查询SN54HC377FK供应商

捷多邦,专业PCB打样工厂SN54时037245SN74HC377 OCTAL D-TYPE FLIP-FLOPS WITH CLOCK ENABLE SCLS307B- JANUARY 1996 - REVISED JANUARY 2003

- Wide Operating Voltage Range of 2 V to 6 V
- Outputs Can Drive Up To 10 LSTTL Loads
- Low Power Consumption, 80-μA Max I_{CC}
- Typical t_{pd} = 12 ns
- ±4-mA Output Drive at 5 V
- Low Input Current of 1 μA Max
- Eight Flip-Flops With Single-Rail Outputs
- Clock Enable Latched to Avoid False Clocking
- Applications Include:
 - Buffer/Storage Registers
 - Shift Registers
 - Pattern Generators

description/ordering information

These devices are positive-edge-triggered octal D-type flip-flops with an enable input. The 'HC377 devices are similar to the 'HC273 devices, but feature a latched clock-enable (CLKEN) input instead of a common clear.

Information at the data (D) inputs meeting the setup time requirements is transferred to the Q outputs on the positive-going edge of the clock (CLK) pulse, if CLKEN is low. Clock triggering occurs at a particular voltage level and is not directly related to the transition time of the positive-going pulse. When CLK is at either the high or low level, the D input has no effect at the output. These devices are designed to prevent false clocking by transitions at CLKEN.

| SN54HC377 J OR W PACKAGE SN74HC377 DW, N, OR NS PACKAGE (TOP VIEW) | | | | | | | | | | |
|--|---------|----------|-----------------|--|--|--|--|--|--|--|
| CLKEN [1Q [| 1 | 20 19 | V _{CC} | | | | | | | |
| 1D [| 3 | 18 | 8D | | | | | | | |
| 2D [2Q [| 4 5 | 17 16 |] 7D] 7Q | | | | | | | |
| 3Q [| 6 | 15 |] 6Q | | | | | | | |
| 3D [4D [| 7 8 | 14 13 |] 6D] 5D | | | | | | | |
| 4Q [GND [| 9 10 | 12 11 |] 5Q] CLK | | | | | | | |
| _ | | | | | | | | | | |

SN54HC377 ... FK PACKAGE (TOP VIEW)

| ļ | 1 | 1a | CLKEN | Vcc | 8Q | | | |
|-------------------------------|--------------------------|---------------------------------|--------------------------------------|---|---|---|---|--|
| 4] 5] 6] 7] 8 | 3 | 2 10 | 1 | 20 12 | 19 1 1 1 1 1 13 | 7 [6 [5] | 8D 7D 7Q 6Q 6D | |
| | | 0 | | | | | | |
| |] 4] 5] 6] 7 | 4 3 5 6 7 8 9 | 3 2 4 5 6 7 8 9 10 | 3 2 1 4 5 6 7 8 9 10 11 | 3 2 1 20 4 5 6 7 8 9 10 11 12 9 10 11 12 | 3 2 1 20 19 3 2 1 20 19 4 1 5 1 6 1 7 1 8 1 9 10 11 12 13 | $\begin{bmatrix} 3 & 2 & 1 & 20 & 19 \\ 4 & & 18 \\ 5 & & 17 \\ 6 & & 16 \\ 7 & & 15 \\ 8 & & 14 \\ 9 & 10 & 11 & 12 & 13 \\ \end{bmatrix}$ | 3 2 1 20 19 18 8D 5 17 7D 6 16 7Q 7 15 6Q 8 14 6D 9 10 11 12 |

| TA | PACKA | GE† | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|-----------|---------------|--------------------------|---------------------|
| | PDIP – N | Tube | SN74HC377N | SN74HC377N |
| | | Tube | SN74HC377DW | 110077 |
| –40°C to 85°C | SOIC – DW | Tape and reel | SN74HC377DWR | HC377 |
| | SOP – NS | Tape and reel | SN74HC377NSR | HC377 |
| | CDIP – J | Tube | SNJ54HC377J | SNJ54HC377J |
| –55°C to 125°C | CFP – W | Tube | SNJ54HC377W | SNJ54HC377W |
| | LCCC – FK | Tube | SNJ54HC377FK | SNJ54HC377FK |

ORDERING INFORMATION

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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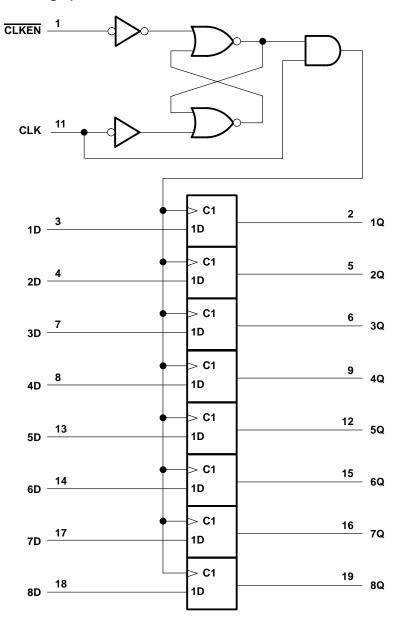


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| FUNCTION TABLE (each flip-flop) | | | | | | | | | | |
|------------------------------------|------------|---|----------------|--|--|--|--|--|--|--|
| INPUTS OUTPUT | | | | | | | | | | |
| CLKEN | CLK | D | Q | | | | | | | |
| Н | Х | Х | Q ₀ | | | | | | | |
| L | \uparrow | Н | н | | | | | | | |
| L | \uparrow | L | L | | | | | | | |
| х | L | Х | Q ₀ | | | | | | | |

logic diagram (positive logic)





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

| Supply voltage range, V _{CC} | –0.5 V to 7 V |
|---|----------------|
| Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$) (see Note 1) | |
| Output clamp current, I_{OK} (V _O < 0 or V _O > V _{CC}) (see Note 1) | |
| Continuous output current, I_{O} (V_{O} = 0 to V_{CC}) | |
| Continuous current through V _{CC} or GND | |
| Package thermal impedance, θ_{IA} (see Note 2): DW package | |
| N package | |
| NS package | |
| Storage temperature range, T _{stg} | –65°C to 150°C |

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 3)

| | | | SN | 154HC37 | 7 | SN | 174HC37 | 7 | |
|-----------------------|---------------------------------|-------------------------|------|---------|------|------|---------|------|------|
| | | | MIN | NOM | MAX | MIN | NOM | MAX | UNIT |
| VCC | Supply voltage | | 2 | 5 | 6 | 2 | 5 | 6 | V |
| | | $V_{CC} = 2 V$ | 1.5 | | | 1.5 | | | |
| ∨ _{IH} н | High-level input voltage | $V_{CC} = 4.5 V$ | 3.15 | | | 3.15 | | | V |
| | | VCC = 6 V | 4.2 | | | 4.2 | | | |
| | Low-level input voltage | $V_{CC} = 2 V$ | | | 0.5 | | | 0.5 | |
| VIL | | $V_{CC} = 4.5 V$ | | | 1.35 | | | 1.35 | V |
| | | $V_{CC} = 6 V$ | | | 1.8 | | | 1.8 | |
| VI | Input voltage | | 0 | | VCC | 0 | | VCC | V |
| VO | Output voltage | | 0 | | VCC | 0 | | VCC | V |
| | | $V_{CC} = 2 V$ | | | 1000 | | | 1000 | |
| $\Delta t / \Delta v$ | Input transition rise/fall time | V _{CC} = 4.5 V | | | 500 | | | 500 | ns |
| | | V _{CC} = 6 V | | | 400 | | | 400 | |
| Т _А | Operating free-air temperature | | -55 | | 125 | -40 | | 85 | °C |

NOTE 3: All unused inputs of the device must be held at VCC or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| | TEAT OF | TEST CONDITIONS | | Т | A = 25°C | ; | SN54H | C377 | SN74HC377 | | UNIT |
|-----------|-------------------------------------|---------------------------|------------|------|----------|------|-------|-------|-----------|-------|------|
| PARAMETER | ER TEST CONDITIONS | | VCC | MIN | TYP | MAX | MIN | MAX | MIN | MAX | UNIT |
| | | | 2 V | 1.9 | 1.998 | | 1.9 | | 1.9 | | |
| | | I _{OH} = -20 μA | 4.5 V | 4.4 | 4.499 | | 4.4 | | 4.4 | | |
| VOH | $V_{I} = V_{IH} \text{ or } V_{IL}$ | | 6 V | 5.9 | 5.999 | | 5.9 | | 5.9 | | V |
| | | $I_{OH} = -4 \text{ mA}$ | 4.5 V | 3.98 | 4.3 | | 3.7 | | 3.84 | | |
| | | I _{OH} = -5.2 mA | 6 V | 5.48 | 5.8 | | 5.2 | | 5.34 | | |
| | | | 2 V | | 0.002 | 0.1 | | 0.1 | | 0.1 | |
| | VI = VIH or VIL | l _{OL} = 20 μA | 4.5 V | | 0.001 | 0.1 | | 0.1 | | 0.1 | |
| VOL | | | 6 V | | 0.001 | 0.1 | | 0.1 | | 0.1 | V |
| | | I _{OL} = 4 mA | 4.5 V | | 0.17 | 0.26 | | 0.4 | | 0.33 | |
| | | I _{OL} = 5.2 mA | 6 V | | 0.15 | 0.26 | | 0.4 | | 0.33 | |
| lj | $V_{I} = V_{CC} \text{ or } 0$ | | 6 V | | ±0.1 | ±100 | | ±1000 | | ±1000 | nA |
| Icc | $V_{I} = V_{CC} \text{ or } 0,$ | I _O = 0 | 6 V | | | 8 | | 160 | | 80 | μA |
| Ci | | | 2 V to 6 V | | 3 | 10 | | 10 | | 10 | pF |

timing requirements over recommended operating free-air temperature range (unless otherwise noted)

| | | | | T _A = 2 | 25°C | SN54H | C377 | SN74H | IC377 | |
|-----------------|------------------------------------|--------------------------------|-------|--------------------|------|-------|------|-------|-------|------|
| | | | vcc | MIN | MAX | MIN | MAX | MIN | MAX | UNIT |
| | | | 2 V | | 5 | | 3 | | 4 | |
| fclock | fclock Clock frequency | | | | 25 | | 16 | | 20 | MHz |
| | | | | | 29 | | 19 | | 23 | |
| | | | 2 V | 100 | | 150 | | 125 | | |
| tw | tw Pulse duration, CLK high or low | | | 20 | | 30 | | 25 | | ns |
| | | | 6 V | 17 | | 25 | | 21 | | |
| | | | 2 V | 100 | | 150 | | 125 | | ns |
| | | D | 4.5 V | 20 | | 30 | | 25 | | |
| | | | 6 V | 17 | | 25 | | 21 | | |
| t _{su} | Setup time before CLK↑ | | 2 V | 100 | | 150 | | 125 | | |
| | | CLKEN high or low | 4.5 V | 20 | | 30 | | 25 | | |
| | | | 6 V | 17 | | 25 | | 21 | | |
| | | | 2 V | 5 | | 5 | | 5 | | |
| ^t h | Hold time after CLK↑ | CLKEN inactive or active, data | 4.5 V | 5 | | 5 | | 5 | | ns |
| | | | 6 V | 5 | | 5 | | 5 | | |



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switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

| | FROM | TO (OUTPUT) | | T _A = 25°C | | SN54HC377 | | SN74HC377 | | UNIT | |
|------------------|---------|----------------|-------|-----------------------|-----|-----------|-----|-----------|-----|------|------|
| PARAMETER | (INPUT) | | vcc | MIN | TYP | MAX | MIN | MAX | MIN | MAX | UNIT |
| | | | 2 V | 5 | 11 | | 3 | | 4 | | |
| ^f max | | | 4.5 V | 25 | 54 | | 16 | | 20 | | MHz |
| | | | 6 V | 29 | 64 | | 19 | | 23 | | |
| | CLK | CLK Any | 2 V | | 56 | 160 | | 240 | | 200 | |
| ^t pd | | | 4.5 V | | 15 | 32 | | 48 | | 40 | ns |
| | | | 6 V | | 12 | 27 | | 41 | | 34 | |
| | | | 2 V | | 38 | 75 | | 110 | | 95 | |
| tt | | Any | 4.5 V | | 8 | 15 | | 22 | | 19 | ns |
| | | | 6 V | | 6 | 13 | | 19 | | 16 | |

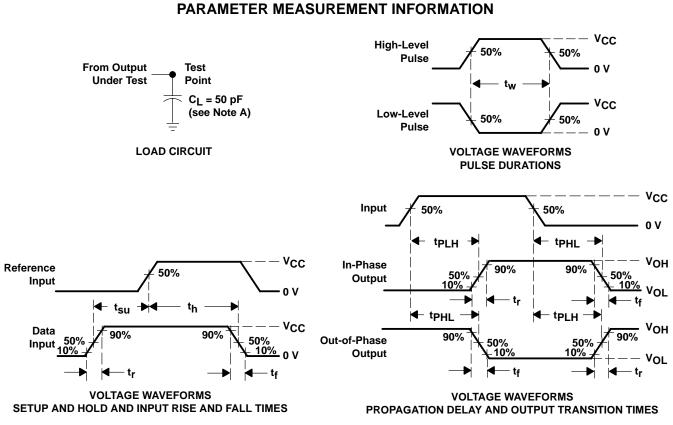
operating characteristics, $T_A = 25^{\circ}C$

| | PARAMETER | TEST CONDITIONS | TYP | UNIT |
|-----|---|-----------------|-----|------|
| Cpd | Power dissipation capacitance per flip-flop | No load | 30 | рF |



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- NOTES: A. CL includes probe and test-fixture capacitance.
 - B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_Q = 50 Ω , t_f = 6 ns, t_f = 6 ns.
 - C. For clock inputs, $f_{\mbox{max}}$ is measured when the input duty cycle is 50%.
 - D. The outputs are measured one at a time with one input transition per measurement.
 - E. tPLH and tPHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms





PACKAGE OPTION ADDENDUM

30-Mar-2005

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|-----------------|--------------------|------|----------------|-------------------------|------------------|--|
| 5962-87807012A | ACTIVE | LCCC | FK | 20 | 1 | TBD | Call TI | Level-NC-NC-NC |
| 5962-8780701RA | ACTIVE | CDIP | J | 20 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SN54HC377J | ACTIVE | CDIP | J | 20 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SN74HC377DW | ACTIVE | SOIC | DW | 20 | 25 | Pb-Free (RoHS) | CU NIPDAU | Level-2-250C-1 YEAR/ Level-1-235C-UNLIM |
| SN74HC377DWR | ACTIVE | SOIC | DW | 20 | 2000 | Pb-Free (RoHS) | CU NIPDAU | Level-2-250C-1 YEAR/ Level-1-235C-UNLIM |
| SN74HC377N | ACTIVE | PDIP | Ν | 20 | 20 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| SN74HC377NSR | ACTIVE | SO | NS | 20 | 2000 | Pb-Free (RoHS) | CU NIPDAU | Level-2-260C-1 YEAR/ Level-1-235C-UNLIM |
| SNJ54HC377FK | ACTIVE | LCCC | FK | 20 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SNJ54HC377J | ACTIVE | CDIP | J | 20 | 1 | TBD | Call TI | Level-NC-NC-NC |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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J (R-GDIP-T**) 14 LEADS SHOWN

PINS ** 14 16 20 18 DIM 0.300 0.300 0.300 0.300 В Α (7,62) (7,62) (7,62) (7,62) BSC BSC BSC BSC 14 8 0.785 .840 0.960 1.060 B MAX (19, 94)(21, 34)(24, 38)(26, 92)B MIN С 0.300 0.300 0.310 0.300 C MAX (7, 62)(7, 62)(7, 87)(7, 62)7 0.245 0.245 0.220 0.245 0.065 (1,65) C MIN (6, 22)(6,22) (5, 59)(6,22) 0.045 (1,14) 0.060 (1,52) ← 0.005 (0,13) MIN Α 0.015 (0,38) 0.200 (5,08) MAX Seating Plane 0.130 (3,30) MIN 0.026 (0,66) 0.014 (0,36) 0'-15' 0.100 (2,54) 0.014 (0,36) 0.008 (0,20) 4040083/F 03/03

CERAMIC DUAL IN-LINE PACKAGE

NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.

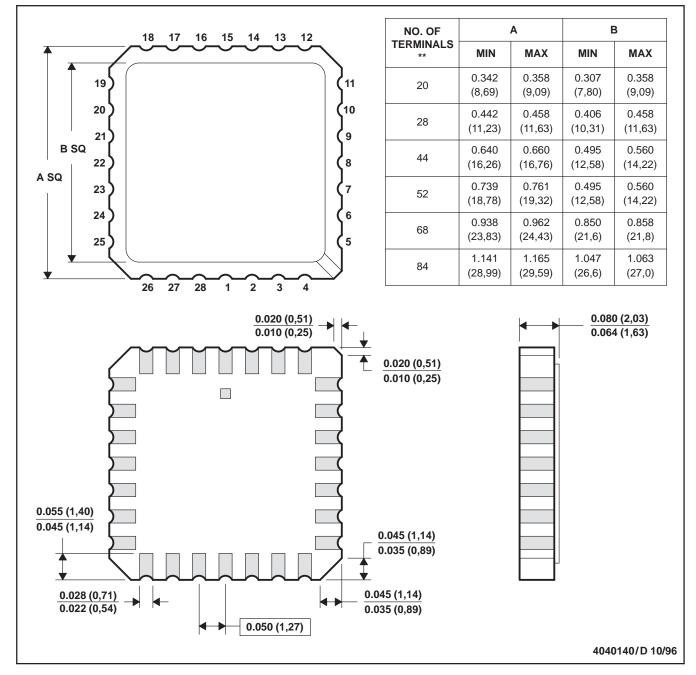
E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

MECHANICAL DATA

MLCC006B - OCTOBER 1996

LEADLESS CERAMIC CHIP CARRIER

FK (S-CQCC-N**) 28 TERMINAL SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

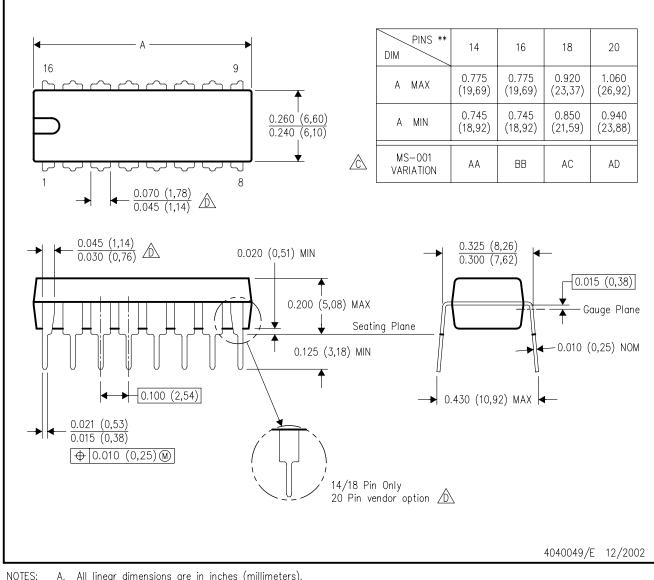
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

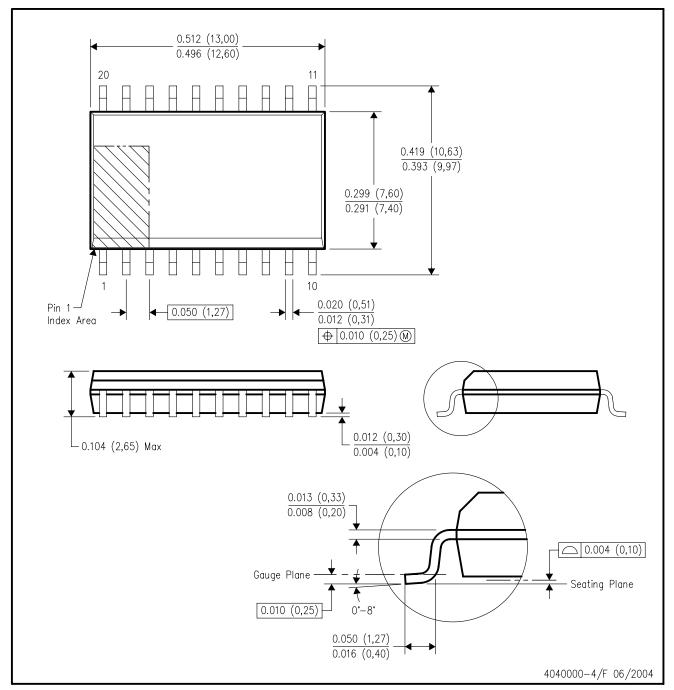
🖄 Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).

The 20 pin end lead shoulder width is a vendor option, either half or full width.



DW (R-PDSO-G20)

PLASTIC SMALL-OUTLINE PACKAGE



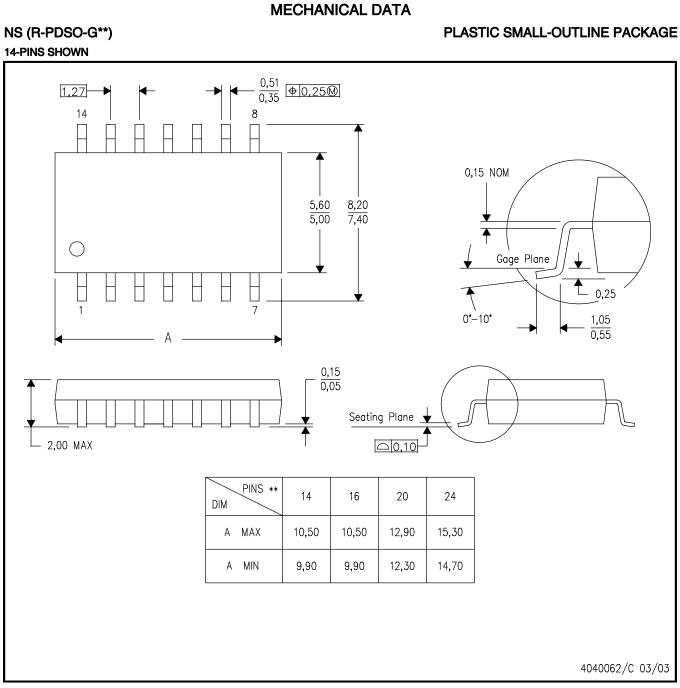
NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-013 variation AC.





NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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